

FDA33N25 N-Channel UniFETTM MOSFET 250 V, 33 A, 940 mΩ

Features

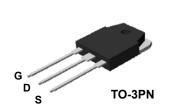
- $R_{DS(on)}$ = 880 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 16.5 A
- Low Gate Charge (Typ. 36 nC)
- Low C_{rss} (Typ. 35 pF)
- 100% Avalanche Tested
- RoHS compliant

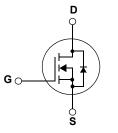
Applications

- PDP TV
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

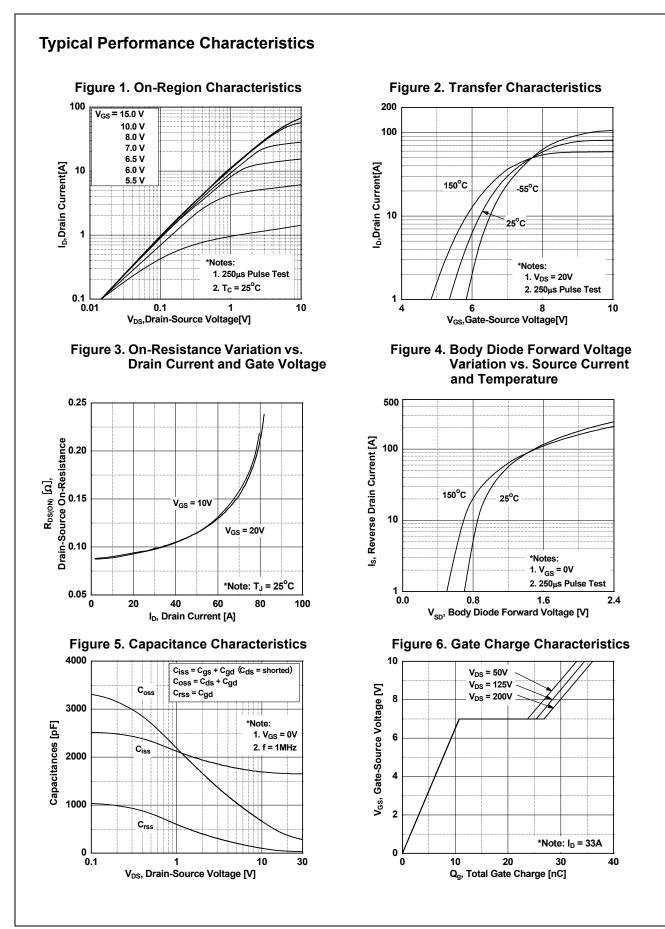
Symbol	Parameter			FDA33N25	Unit	
V _{DSS}	Drain to Source Voltage	ain to Source Voltage			V	
V _{GSS}	Gate to Source Voltage			±30	V	
	Drain Current	- Continuous (T _C = 25 ^o C)		33		
ID	Drain Current	- Continuous (T _C = 100 ^o C)		21	— A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	132	А	
E _{AS}	Single Pulsed Avalanche E	(Note 2)	918	mJ		
I _{AR}	Avalanche Current		(Note 1)	33	А	
E _{AR}	Repetitive Avalanche Energ	уу	(Note 1)	24.6	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns	
P _D	Davida Dia dia atian	$(T_{C} = 25^{\circ}C)$		245	W	
	Power Dissipation	- Derate above 25°C		1.96	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

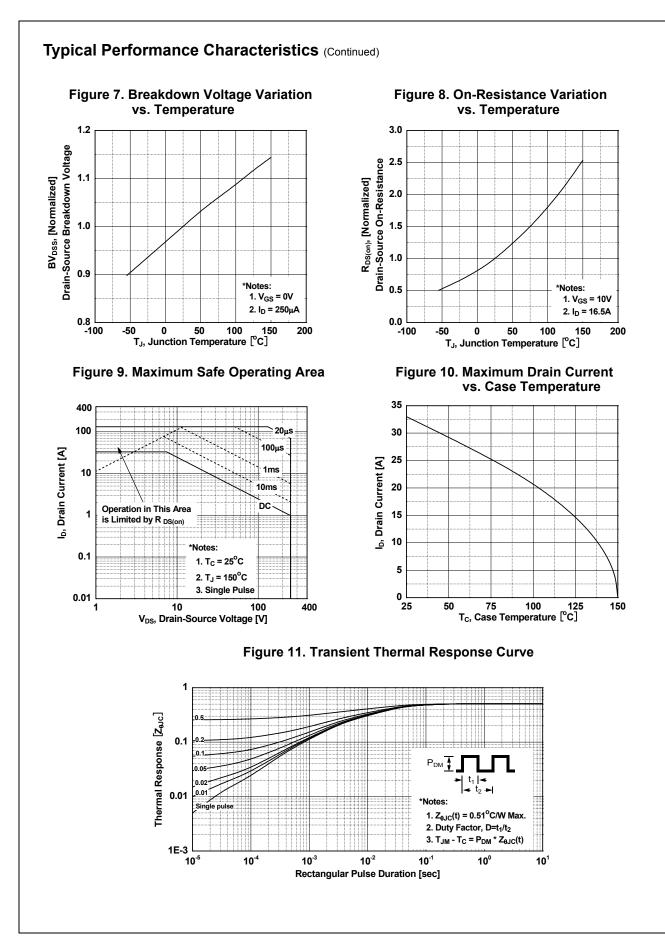
Thermal Characteristics

Symbol	Parameter	FDA33N25	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.51	
$R_{\theta CS}$	Thermal Resistance, Case to Sink, Typ.	0.24	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	

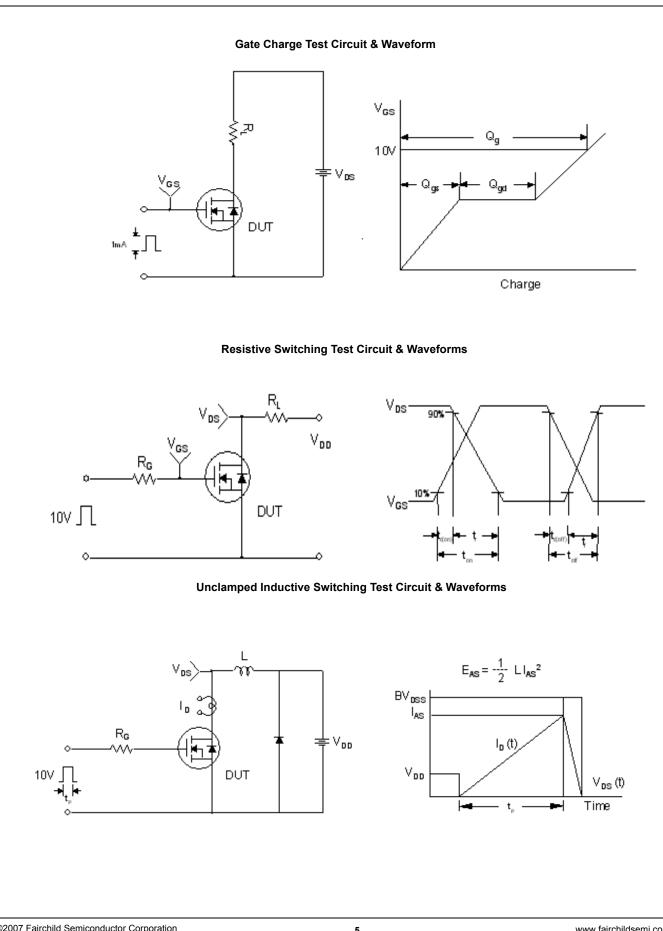
March 2013

-		Packa	ge	Reel Size	Тар	e Width Quantity			у	
		TO-3F				-		50		
Electrica	l Chara	acteristics T _C =	= 25ºC unles	s otherw	rise noted					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charad	cteristics	5								
BV _{DSS}			/oltage	ln = 2	250μA, V _{GS} = 0V, T _J =	= 25°C	250	-	-	V
∆BV _{DSS}	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient		-			200				
ΔT_J				$I_D = 250\mu A$, Referenced to $25^{\circ}C$			-	0.34	-	V/ºC
	Zero Gate Voltage Drain Current		V _{DS} = 250V, V _{GS} = 0V		-	-	1	μA		
I _{DSS}	2010 00			V _{DS} = 200V, T _C = 125 ^o C			-	-	10	- μΑ
I _{GSS}	Gate to	Body Leakage Curre	nt	V _{GS} =	= ±30V, V _{DS} = 0V		-	-	±100	nA
On Charac	teristics	5								
V _{GS(th)}	Gate Th	reshold Voltage		VGS	= V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		rain to Source On Re	sistance		= 10V, I _D = 16.5A		-	0.088	0.094	Ω
9FS	Forward Transconductance			$V_{DS} = 20V, I_D = 16.5A$			-	24.2	-	S
	baracto	rictice				1				1
Dynamic C	1			_				4055	2200	
C _{iss}		apacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	1655	2200	pF	
C _{oss}						-	315	420	pF	
C _{rss}		Transfer Capacitanc	e	_			-	35	55	pF
Q _{g(tot)}		te Charge at 10V		V _{DS} = 200V, I _D = 33A V _{GS} = 10V (Note 4)		-	36	46.8	nC	
Q _{gs}		Source Gate Charge				-	10.8	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge				-	16	-	nC	
Switching	Charact	eristics								
t _{d(on)}		Delay Time		$V_{DD} = 125V, I_D = 33A$ $R_G = 25\Omega$ (Note 4)		-	33	76	ns	
t _r		Rise Time				-	142	293	ns	
t _{d(off)}	Turn-Off	Delay Time				-	77	165	ns	
t _f		Fall Time				-	68	146	ns	
	roo Diod	le Characteristic								L
•	-1			do Foru	and Current				22	•
I _S	Maximum Continuous Drain to Source Diode For			_		-	-	33	A	
I _{SM}			d Drain to Source Diode F				-	-	132	A V
V _{SD}		Source Diode Forwar	d voltage	$\begin{array}{c c} V_{GS} = 0V, \ I_{SD} = 33A \\ \hline \\ V_{GS} = 0V, \ I_{SD} = 33A \\ \hline \\ dI_{F}/dt = 100A/\mu s \end{array}$		-	-	1.4	-	
t _{rr}		Recovery Time				-	256	-	ns	
Q _{rr} Notes:	Reverse	Recovery Charge		ui _F /ui	ι – 100Α/μs		-	2.3	-	μC



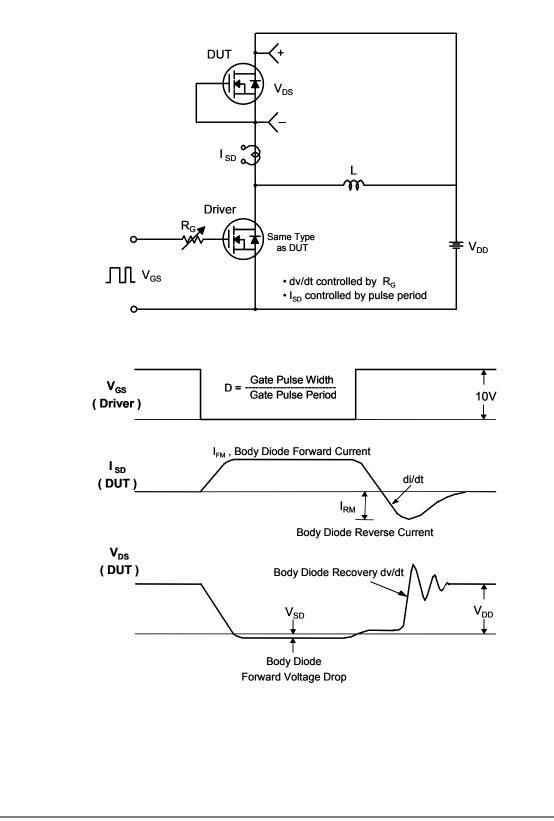


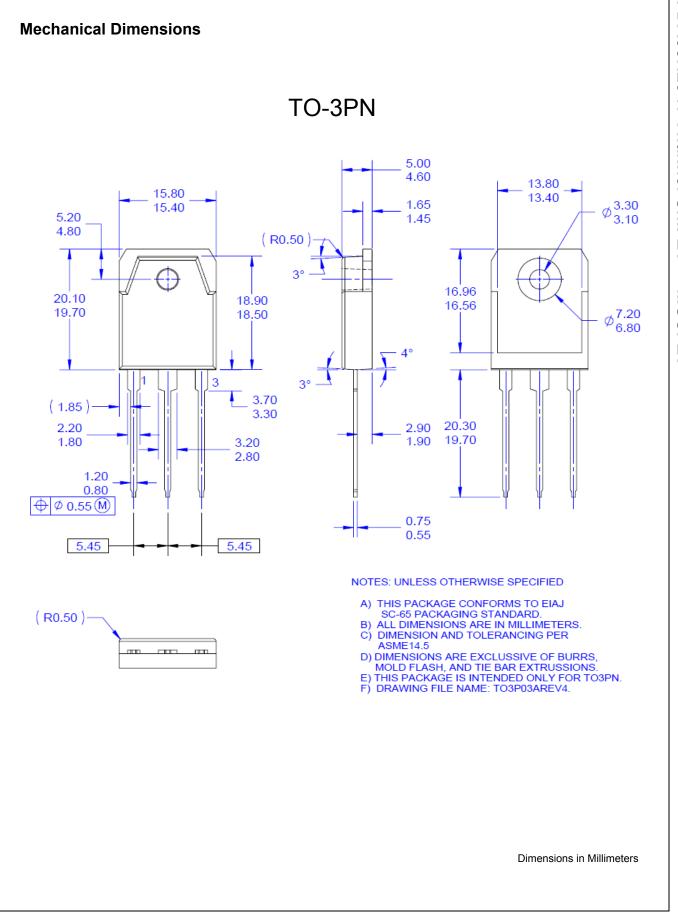
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Peak Diode Recovery dv/dt Test Circuit & Waveforms







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